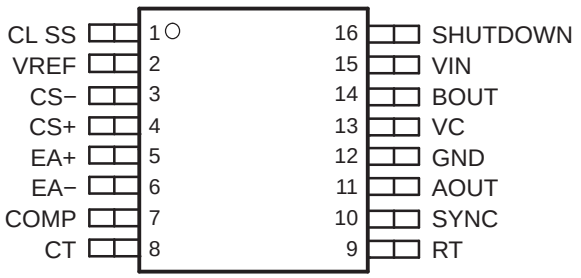
IMPROVED CURRENT-MODE PWM CONTROLLER

Check for Samples: UC2856-Q1

FEATURES

- **Qualified for Automotive Applications**
- **Pin-for-Pin Compatible With the UC2846**
- **65-ns Typical Delay From Shutdown to Outputs and 50-ns Typical Delay From Sync to Outputs**
- **Improved Current Sense Amplifier With Reduced Noise Sensitivity**
- **Differential Current Sense With 3-V Common-Mode Range**
- **Trimmed Oscillator Discharge Current for Accurate Deadband Control**
- **Accurate 1-V Shutdown Threshold**
- **High Current Dual Totem Pole Outputs (1.5-A Peak)**
- **TTL Compatible Oscillator SYNC Pin Thresholds**
- **ESD Protection**
  - **4-kV Human-Body Model (HBM)**
  - **500-V Charged-Device Model (CDM)**

DW PACKAGE
(TOP VIEW)



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DESCRIPTION

The UC2856 is a high performance version of the popular UC2846 series of current mode controllers, and is intended for both design upgrades and new applications where speed and accuracy are important. All input to output delays have been minimized, and the current sense output is slew rate limited to reduce noise sensitivity. Fast 1.5-A peak output stages have been added to allow rapid switching of power FETs.

A low impedance TTL compatible sync output has been implemented with a 3-state function when used as a sync input.

Internal chip grounding has been improved to minimize internal noise caused when driving large capacitive loads. This, in conjunction with the improved differential current-sense amplifier, results in enhanced noise immunity.

Other features include a trimmed oscillator current (8%) for accurate frequency and dead-time control, a 1-V 5% shutdown threshold, and 4-kV minimum ESD protection (HBM) on all pins.

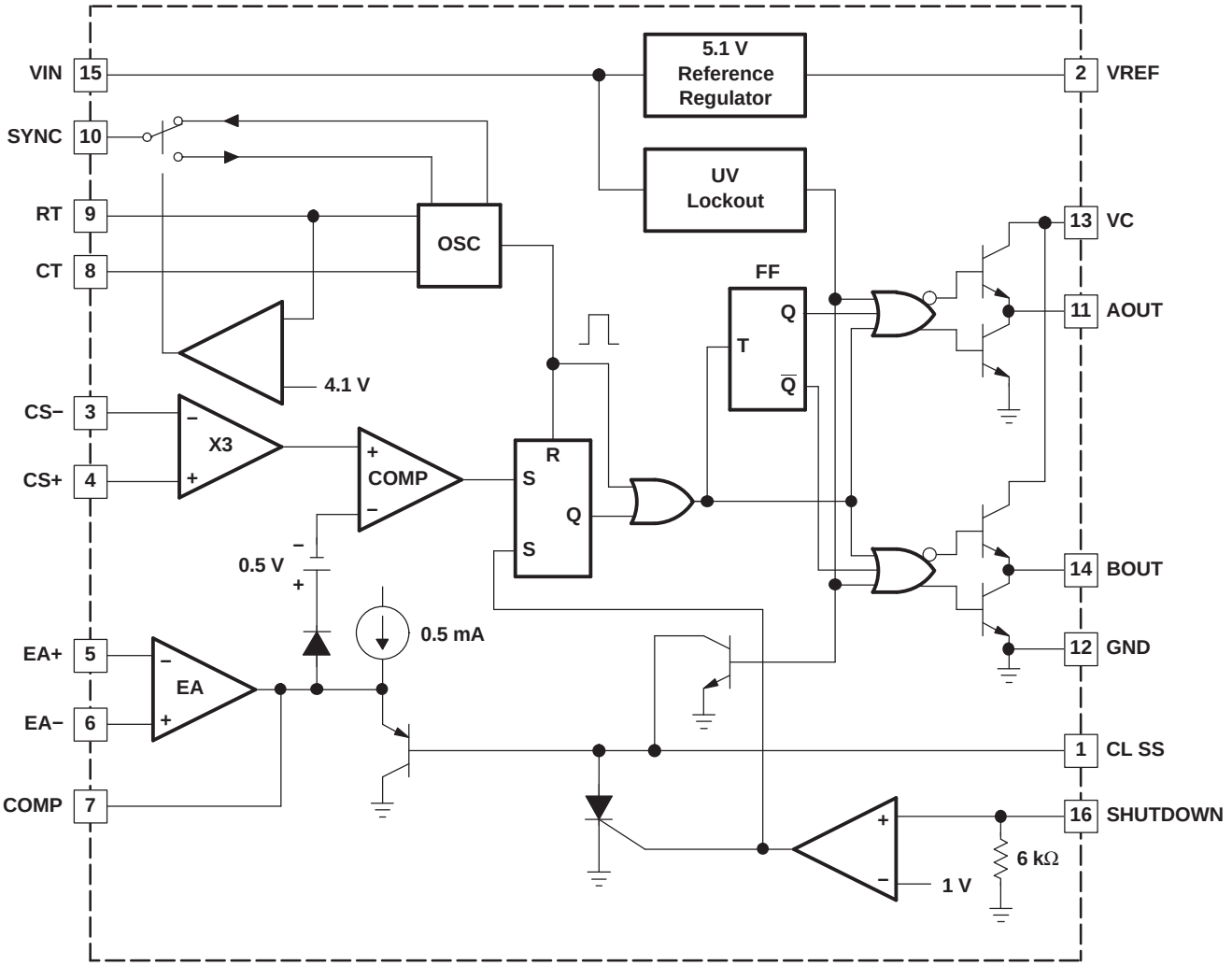
ORDERING INFORMATION(1)

T_A	PACKAGE(2)		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 125°C	SOP – DW	Reel of 2000	UC2856QDWRQ1	UC2856Q1

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at www.ti.com.
(2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

BLOCK DIAGRAM



B0010-01

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)(1) (2)

			UNIT
	Supply voltage		40 V
	Collector supply voltage		40 V
I_O	Output current (sink or source)	DC	0.5 A
		Pulse (0.5 ms)	2 A
	Error amplifier input voltage		–0.3 V to VIN
	Shutdown input voltage		–0.3 V to 10 V
	Current sense input voltage		–0.3 V to 3 V
	SYNC output current		±10 mA
	Error amplifier output current		–5 mA
	Soft start sink current		50 mA
	Oscillator charging current		5 mA
	Power dissipation	T_A = 25°C	1 W
		T_C = 25°C	2 W
T_J	Operating junction temperature range		–55°C to 150°C
T_{stg}	Storage temperature range		–65°C to 150°C
ESD	Electrostatic discharge protection	Human-Body Model (HBM)	4000 V
		Charged-Device Model (CDM)	500 V

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) Unless otherwise indicated, voltages are reference to ground and currents are positive into and negative out of the specified terminals.

ELECTRICAL CHARACTERISTICS

T_A = –40°C to 125°C, VIN = 15 V, RT = 10 kΩ, CT = 1 nF, and $T_A = T_J$ (unless otherwise stated)(1)

PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT
Reference Section						
Output voltage	I_O = 1 mA,	T_J = 25°C	5.05	5.1	5.15	V
Line regulation voltage	VIN = 8 V to 40 V				20	mV
Load regulation voltage	I_O = –1 mA to –10 mA				15	mV
Total output variation	Over line, load, and temperature		5		5.2	V
Output noise voltage	f = 10 Hz to 10 kHz,	T_J = 25°C		50		µV
Long term stability	1000 hours, (2)	T_J = 25°C		5	25	mV
Short circuit current	VREF = 0 V		–25	–45	–65	mA
Oscillator Section						
Initial accuracy	T_J = 25°C		180	200	220	kHz
	T_J = Full range		170		230	
Voltage stability	VIN = 8 V to 40 V				2	%
Discharge current	VCT = 2 V,	T_J = 25°C	7.5	8	8.8	mA
	VCT = 2 V		6.7	8	8.8	
Sync output high level voltage	I_O = –1 mA		2.4	3.6		V
Sync output low level voltage	I_O = 1 mA			0.2	0.4	V
Sync input high level voltage	CT = 0 V, RT = VREF		2	1.5		V
Sync input low level voltage	CT = 0 V, RT = VREF			1.5	0.8	V
Sync input current	CT = 0 V, RT = VREF, V_{SYNC} = 5 V			1	10	µA
Sync delay to outputs	CT = 0 V RT = VREF, V_{SYNC} = 0.8 V to 2 V			50	100	ns

(1) All voltages are with respect to GND. Currents are positive into, negative out of the specified terminal.
(2) This parameter, although specified over the recommended operating conditions, is not 100% tested in production.

ELECTRICAL CHARACTERISTICS (continued)

T_A = –40°C to 125°C, VIN = 15 V, RT = 10 kΩ, CT = 1 nF, and $T_A = T_J$ (unless otherwise stated)(1)

PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNIT
Error Amplifier Section						
Input offset voltage	V_{CM} = 2 V				5	mV
Input bias current					–1	µA
Input offset current					500	nA
Common mode range	VIN = 8 V to 40 V		0		VIN–2	V
Open loop gain	V_O = 1.2 V to 3 V		80	100		dB
Unity gain bandwidth	T_J = 25°C		1	1.5		MHz
CMRR	V_{CM} = 0 V to 38 V,	VIN = 40 V	75	100		dB
PSRR	VIN = 8 V to 40 V		80	100		dB
Output sink current	V_{ID} = –15 mV	V_{COMP} = 1.2 V	5	10		mA
Output source current	V_{ID} = 15 mV	V_{COMP} = 2.5 V	–0.4	–0.5		mA
High-level output voltage	V_{ID} = 50 mV,	R_L (COMP) = 15 kΩ	4.3	4.6	4.9	V
Low-level output voltage	V_{ID} = –50 mV,	R_L (COMP) = 15 kΩ		0.7	1	V
Current Sense Amplifier Section						
Amplifier gain	$V_{CS–}$ = 0 V,	CL SS Open(3) (4)	2.5	2.75	3	V/V
Maximum differential input signal ($V_{CS+} – V_{CS–}$)	CL SS Open 3,	R_L (COMP) = 15 kΩ	1.1	1.2		V
Input offset voltage	$V_{CL\ SS}$ = 0.5 V	COMP open(3)		5	35	mV
CMRR	V_{CM} = 0 V to 3 V		60			dB
PSRR	VIN = 8 V to 40 V		60			dB
Input bias current	$V_{CL\ SS}$ = 0.5 V,	COMP open(3)	–1		1	µA
Input offset current	$V_{CL\ SS}$ = 0.5 V,	COMP open(3)	–1		1	µA
Input common mode range			0		3	V
Delay to outputs	V_{EA+} = VREF, EA– = 0 V, CS+ – CS– = 0 V to 1.5 V			120	250	ns
Current Limit Adjust Section						
Current limit offset	$V_{CS–}$ = 0 V, V_{CS+} = 0 V,	COMP open(3)	0.4	0.5	0.6	V
Input bias current	V_{EA+} = VREF,	$V_{EA–}$ = 0 V		–10	–30	µA
SHUTDOWN Terminal Section						
Threshold voltage			0.95	1.00	1.05	V
Input voltage range			0		5	V
Minimum latching current ($I_{CL\ SS}$)			(5)3	1.5		mA
Maximum non-latching current ($I_{CL\ SS}$)				(6)1.5	0.8	mA
Delay to outputs	$V_{SHUTDOWN}$ = 0 V to 1.3 V			65	110	ns

(3) Parameter measured at trip point of latch with VEA+ = VREF, VEA– = 0 V.

(4) Amplifier gain defined as: $G = \frac{\Delta V_{COMP}}{\Delta V_{CS+}}$; $\Delta V_{CS} - = 0\ V\ 1\ V$.

(5) Current into CL SS assured to latch circuit into shutdown state.

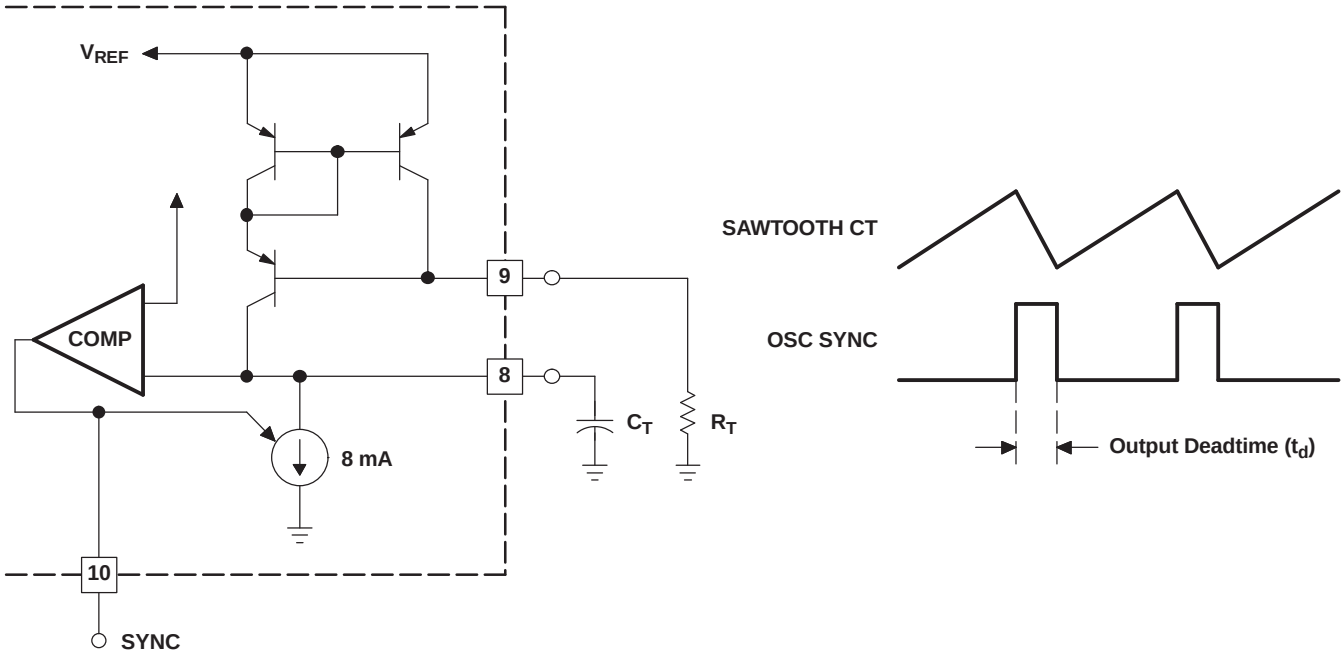
(6) Current into CL SS assured not to latch circuit into shutdown state.

ELECTRICAL CHARACTERISTICS (continued)

T_A = –40°C to 125°C, VIN = 15 V, RT = 10 kΩ, CT = 1 nF, and $T_A = T_J$ (unless otherwise stated)[1]

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Output Section					
Collector-emitter voltage		40			V
Off-state bias current	VC = 40 V			250	µA
Output low level voltage	I_{OUT} = 20 mA		0.1	0.5	V
	I_{OUT} = 200 mA		0.5	2.6	
Output high level voltage	I_{OUT} = –20 mA	12.5	13.2		V
	I_{OUT} = –200 mA	12	13.1		
Rise time	C1 = 1 nF		40	80	ns
Fall time	C1 = 1 nF		40	80	ns
UVLO low saturation	VIN = 0 V, I_{OUT} = 20 mA		0.8	1.5	V
PWM Section					
Maximum duty cycle		45	47	50	%
Minimum duty cycle				0	%
Undervoltage Lockout Section					
Startup threshold			7.7	8	V
Threshold hysteresis			0.7		V
Total Standby Current					
Supply current			18	23	mA

APPLICATION AND OPERATION INFORMATION



NOTE: Output deadtime is determined by the size of the external capacitor, C_T, according to the formula: $Td = \frac{2C_T}{8\ mA - \frac{3.6}{R_T}}$

For large values of R_T: $Td = 250\ C_T$

Oscillator frequency is approximated by the formula: $f_T = \frac{2}{R_T \times C_T}$

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Figure 1. Oscillator Circuit

NOTE: Error Amplifier can source up to 0.5 mA.

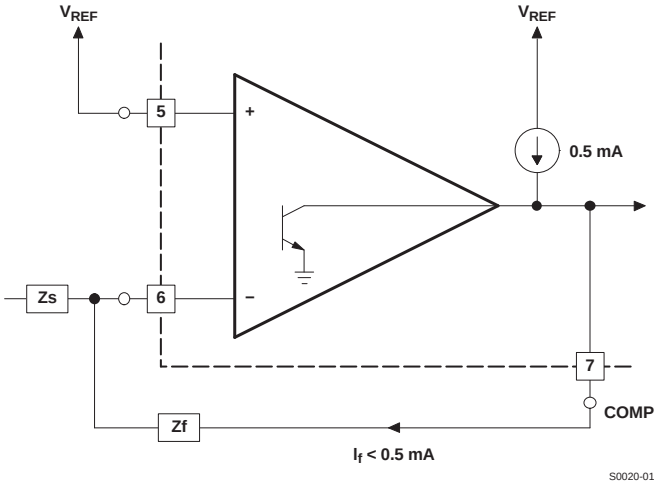


Figure 2. Error Amplifier Output Configuration

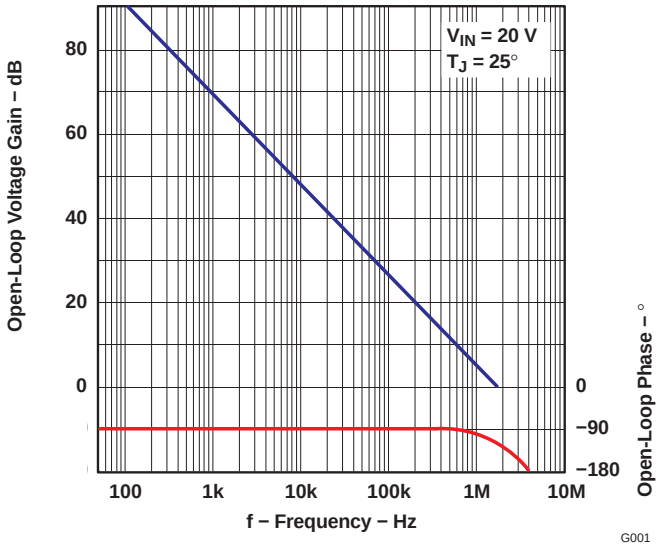


Figure 3. Error Amplifier Gain and Phase vs Frequency

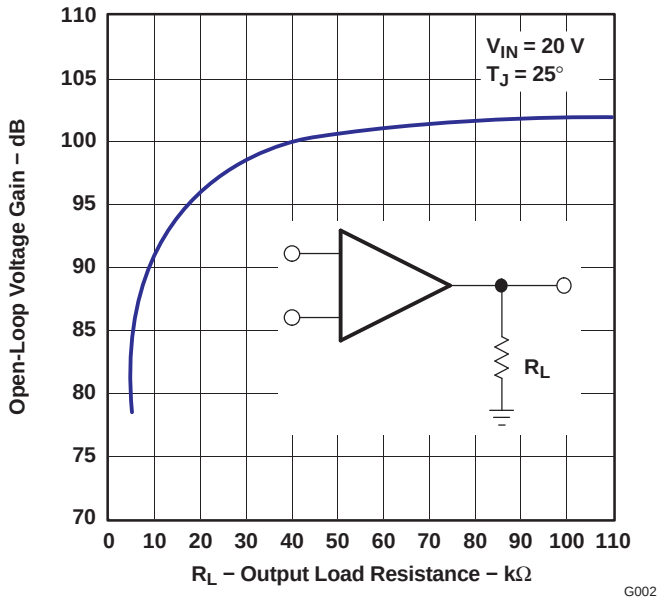
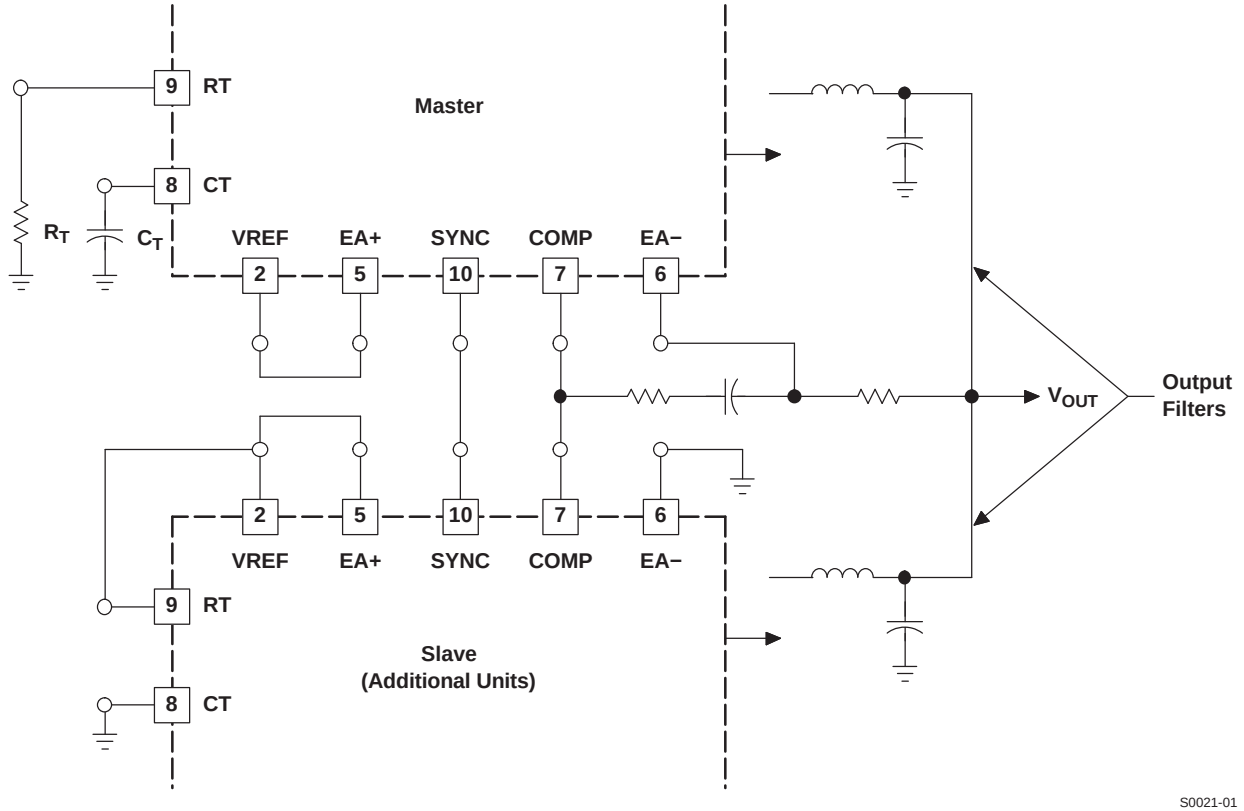
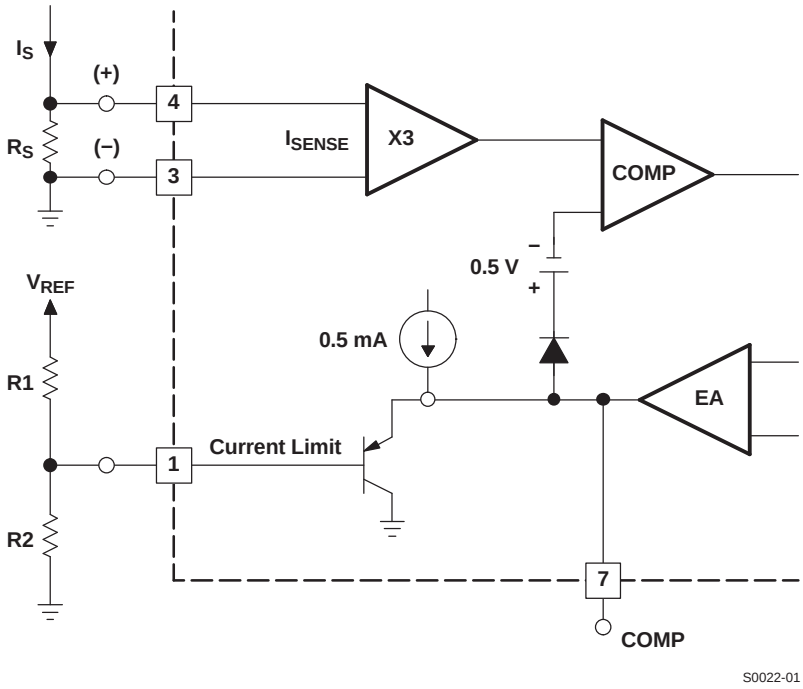


Figure 4. Error Amplifier Open-Loop DC Gain vs Load Resistance



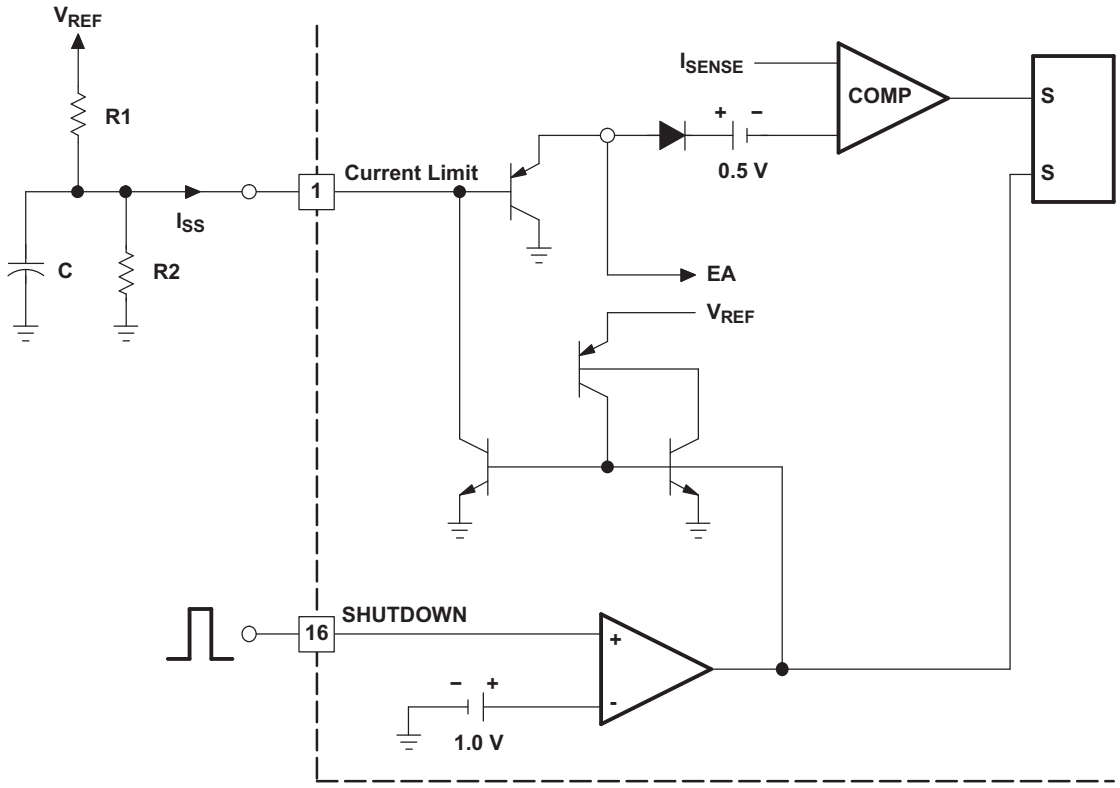
NOTE: Slaving allows parallel operation of two or more units with equal current sharing.

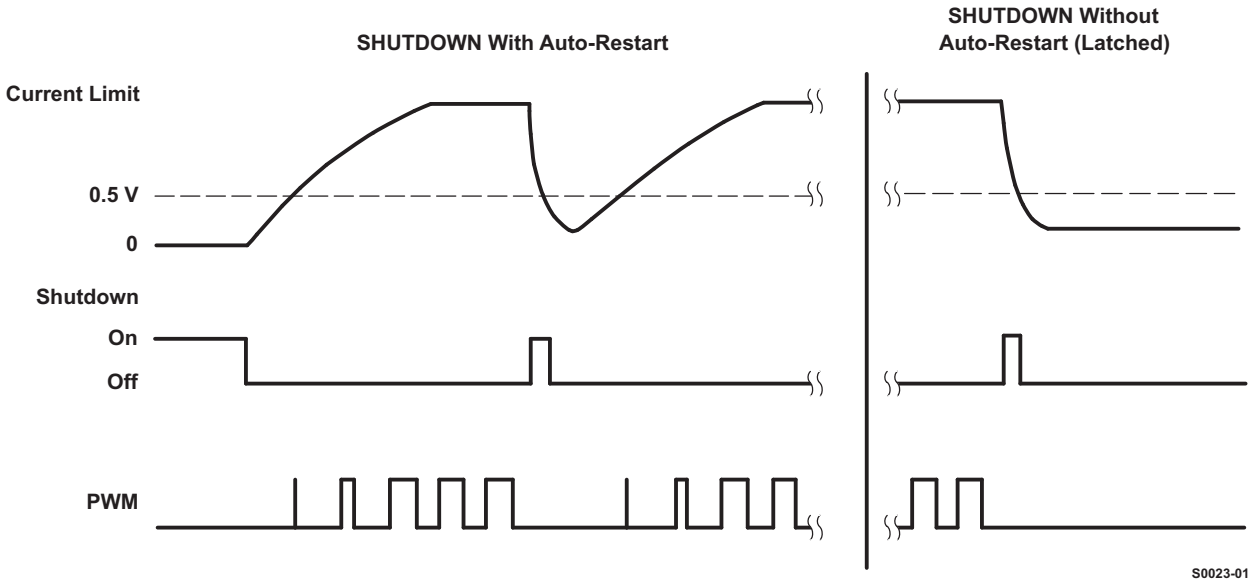
Figure 5. Parallel Operation



NOTE: Peak current (I_S) is determined by the formula: $$I_S = \frac{\left(R2 \times \frac{V_{REF}}{R1+R2}\right) - 0.5}{3R_S}$$

Figure 6. Pulse by Pulse Current Limiting





NOTE: If V_{REF} / R1 < 0.8 mA, the shutdown latch commutates when I_{SS} = 0.8 mA, and a restart cycle is initiated. If V_{REF} / R1 > 3 mA, the device latches off until power is cycled.

Figure 7. Shutdown

REVISION HISTORY

Changes from Original (June 2008) to Revision A **Page**

- Changed the Input bias current Min Value From: - To: -1 and the Max Value From: -1 To: 1 4
- Changed the Input offset current Min Value From: - To: -1 4

Changes from Revision A (October 2010) to Revision B **Page**

- Changed the polarity of the comparitor connected to pin 16 in Figure 7 9

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/ Ball Finish	MSL Peak Temp (3)	Samples (Requires Login)
UC2856QDWRQ1	ACTIVE	SOIC	DW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

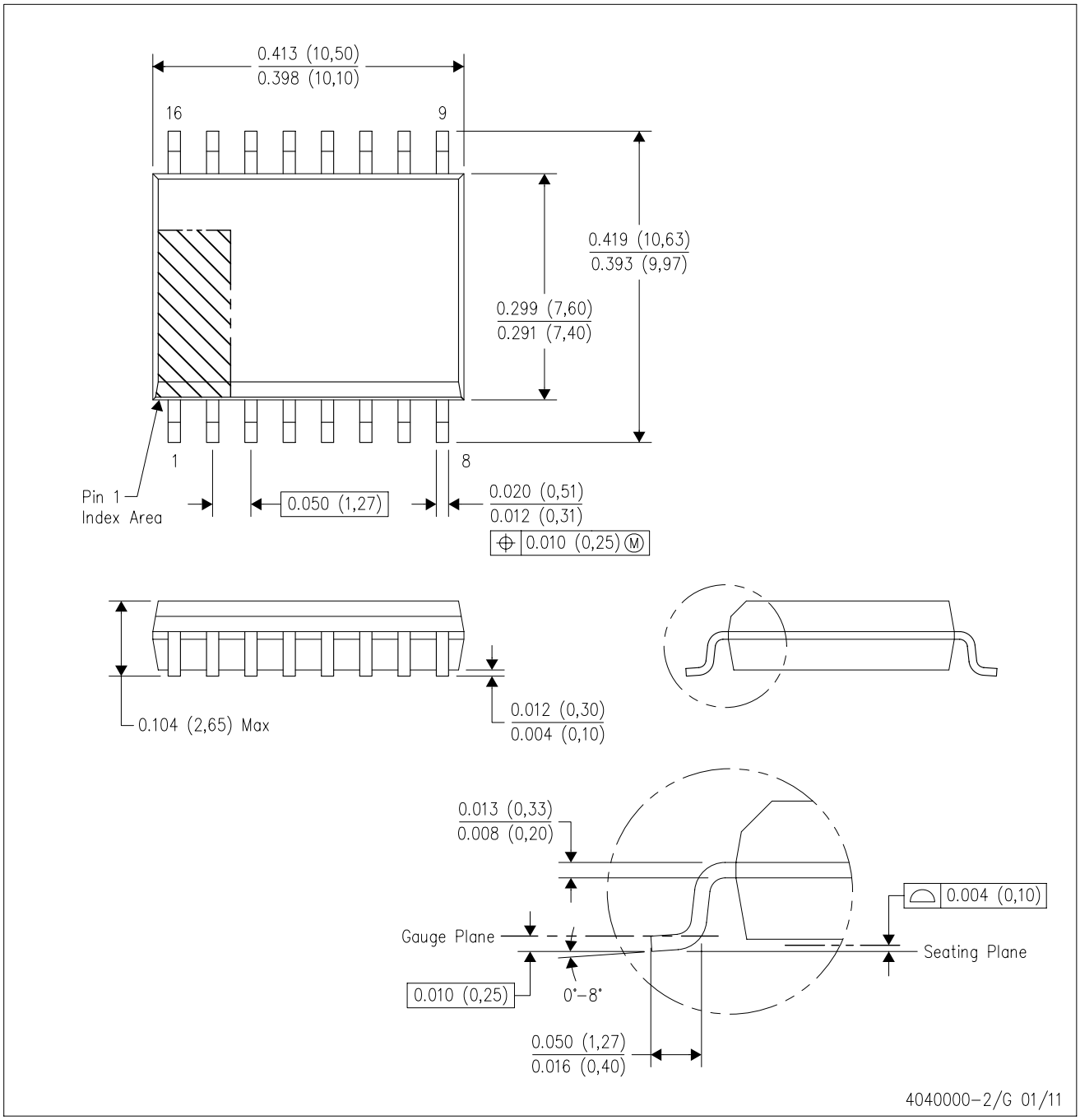
OTHER QUALIFIED VERSIONS OF UC2856-Q1 :

- Catalog: UC2856
- Military: UC2856M

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

DW (R–PDSO–G16) PLASTIC SMALL OUTLINE



NOTES:
A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M–1994.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
D. Falls within JEDEC MS–013 variation AA.

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